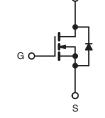


Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|------------------------------|--|--|--|--|
| V _{DS} (V) | 60 | | | | |
| R _{DS(on)} (Ω) | V _{GS} = 5.0 V 0.20 | | | | |
| Q _g (Max.) (nC) | 8.4 | | | | |
| Q _{gs} (nC) | 3.5 | | | | |
| Q _{gd} (nC) | 6.0 | | | | |
| Configuration | Single | | | | |





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION | | | |
|----------------------|------------|--|--|
| Package | TO-220AB | | |
| Lead (Pb)-free | IRLZ14PbF | | |
| | SiHLZ14-E3 | | |
| SnPb | IRLZ14 | | |
| | SiHLZ14 | | |

| ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted) | | | | | | |
|--|--------------------------|---|-----------------------------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V _{DS} | 60 | V | |
| Gate-Source Voltage | | | V _{GS} | ± 10 | v | |
| Continuous Drain Current | V _{GS} at 5.0 V | $T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$ | 1 | 10 | | |
| Continuous Drain Current | V _{GS} at 5.0 V | T _C = 100 °C | ID | 7.2 | A | |
| Pulsed Drain Current ^a | | | I _{DM} | 40 | | |
| Linear Derating Factor | | | | 0.29 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 39.5 | mJ | |
| Maximum Power Dissipation $T_{C} = 25 \text{ °C}$ | | | PD | 43 | W | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 4.5 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 175 | °C | |
| Soldering Recommendations (Peak Temperature) | for | 10 s | | 300 ^d | | |
| Mounting Torque | 6 22 or 1 | 0.00 | | 10 | lbf ∙ in | |
| Mounting Torque | 6-32 or M3 screw | | | 1.1 | N · m | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 0.79 mH, R_g = 25 Ω , I_{AS} = 10 A (see fig. 12).

c. $I_{SD} \leq 10 \text{ A}$, $dl/dt \leq 90 \text{ A}/\mu s$, $V_{DD} \leq V_{DS}$, $T_J \leq 175 \text{ °C}$.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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| THERMAL RESISTANCE | | | | | |
|-------------------------------------|-------------------|------|------|------|------|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | R _{thJA} | - | - | 62 | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | - | 0.50 | - | °C/W |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | - | 3.5 | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|--|---|------|----------|-------|------|--|
| Static | | | | • | • | | • | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} : | = 0 V, I _D = 250 μA | 60 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = 1 mA | - | 0.070 | - | V/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | 1.0 | - | 2.0 | V | |
| Gate-Source Leakage | I _{GSS} | | V _{GS} = ± 10 V | - | - | ± 100 | nA | |
| Zara Cata Valtaga Drain Current | | V _{DS} = 60 V, V _{GS} = 0 V | | - | - | 25 | | |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = 48 V | , V _{GS} = 0 V, T _J = 150 °C | - | - | 250 | μA | |
| Durin Course On State Desistance | P | $V_{GS} = 5.0 V$ | I _D = 6.0 A ^b | - | - | 0.20 | | |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 4.0 \text{ V}$ | I _D = 5.0 A ^b | - | - | 0.28 | Ω | |
| Forward Transconductance | 9 _{fs} | V _{DS} = | = 25 V, I _D = 6.0 A ^b | 3.5 | - | - | S | |
| Dynamic | | · | | | | | • | |
| Input Capacitance | C _{iss} | | V _{GS} = 0 V, | - | 400 | - | pF | |
| Output Capacitance | C _{oss} | | $V_{DS} = 25 V,$ | - | 170 | - | | |
| Reverse Transfer Capacitance | C _{rss} | f = 1 | .0 MHz, see fig. 5 | - | 42 | - | | |
| Total Gate Charge | Qg | | | - | - | 8.4 | nC | |
| Gate-Source Charge | Q _{gs} | V _{GS} = 5.0 V | I _D = 10 A, V _{DS} = 48 V see fig. 6 and 13 ^b | - | - | 3.5 | | |
| Gate-Drain Charge | Q _{gd} | | See lig. 6 and 16 | - | - | 6.0 | | |
| Turn-On Delay Time | t _{d(on)} | | | - | 9.3 | - | | |
| Rise Time | t _r | $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ $R_{g} = 12 \Omega, R_{D} = 2.8 \Omega$ see fig. 10 ^b | | - | 110 | - | ns | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 17 | - | | |
| Fall Time | t _f | | | - | 26 | - | | |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | nH | |
| Internal Source Inductance | L _S | | | - | 7.5 | - | | |
| Drain-Source Body Diode Characteristic | s | | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 10 | | |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 40 | - A | |
| Body Diode Voltage | V _{SD} | $T_J = 25 \text{ °C}, I_S = 10 \text{ A}, V_{GS} = 0 \text{ V}^{b}$ | | - | - | 1.6 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 10 A, dl/dt = 100 A/μs ^b | | - | 93 | 130 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 0.34 | 0.65 | μC | |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L | | | v Le and | Ln) | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

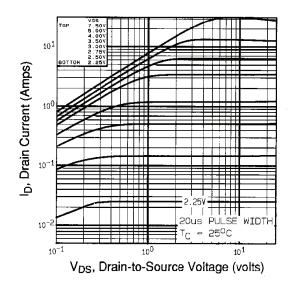


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

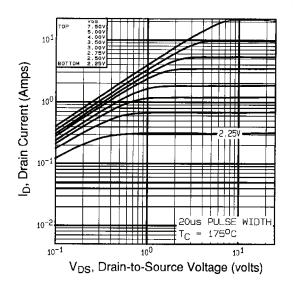


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

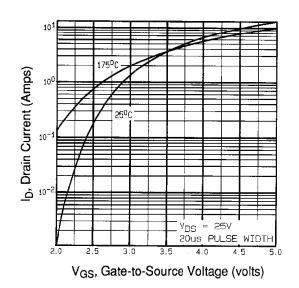


Fig. 3 - Typical Transfer Characteristics

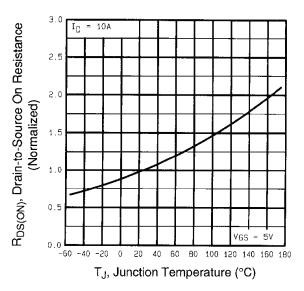


Fig. 4 - Normalized On-Resistance vs. Temperature

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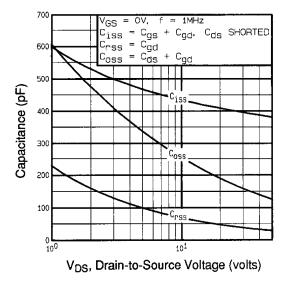
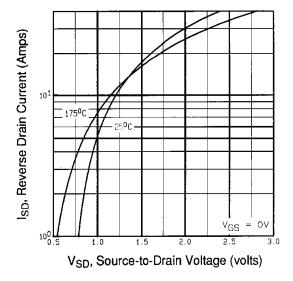
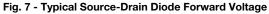


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





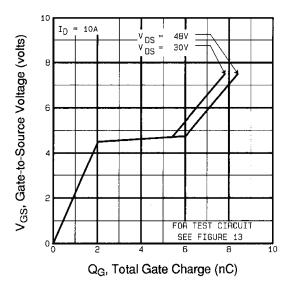
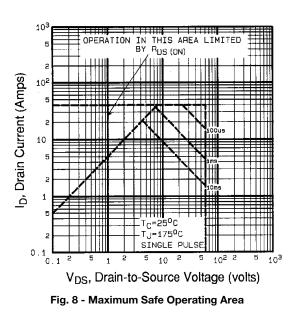


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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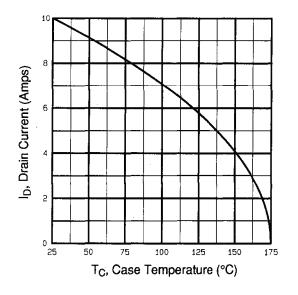


Fig. 9 - Maximum Drain Current vs. Case Temperature

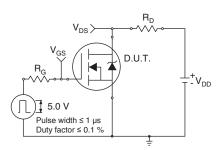


Fig. 10a - Switching Time Test Circuit

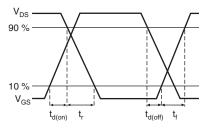


Fig. 10b - Switching Time Waveforms

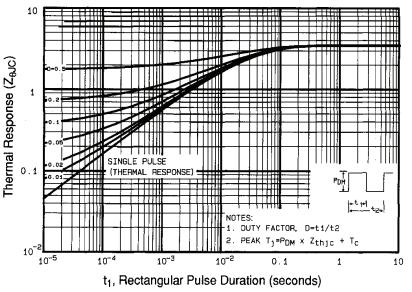


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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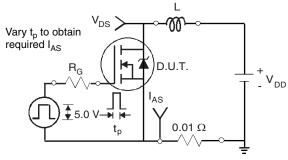


Fig. 12a - Unclamped Inductive Test Circuit

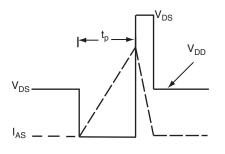


Fig. 12b - Unclamped Inductive Waveforms

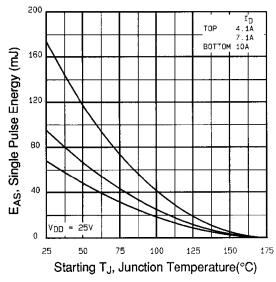
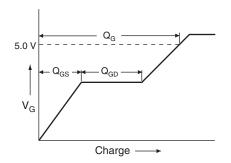


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





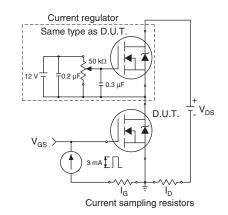
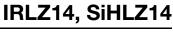


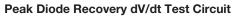
Fig. 13b - Gate Charge Test Circuit

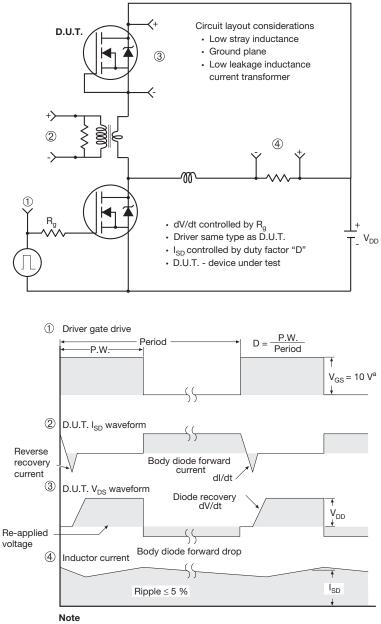
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a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



| DIM. | MILLIN | IETERS | INCHES | | |
|--|--------|--------|--------|-------|--|
| DIN. | MIN. | | MIN. | MAX. | |
| А | 4.24 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | |
| E | 9.96 | 10.52 | 0.392 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | |
| ØР | 3.53 | 3.94 | 0.139 | 0.155 | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | |
| ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031 | | | | | |

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

| Package Picture | | | | | |
|-----------------|--|---------------------|--|--|--|
| ASE | | Xi'an | | | |
| | | IRF 9510 744K AB | | | |

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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